

A O 6804A 20V Dual N-Channel MOSFET

General Description

The AO6804A uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch applications.

Product Summary

 $V_{DS} = 20V$

 $I_D = 5.0A$ $(V_{GS} = 4.5V)$

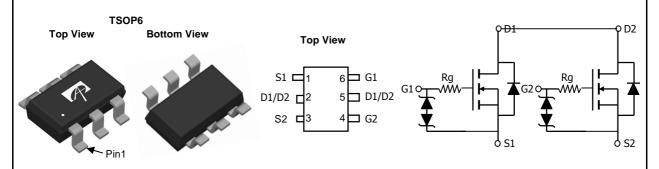
 $R_{DS(ON)}$ < 28m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)} < 30 m\Omega \ (V_{GS} = 4.0 V)$

 $R_{DS(ON)} < 34 m\Omega \; (V_{GS} = 3.1 V)$

 $R_{DS(ON)} < 39 m\Omega \ (V_{GS} = 2.5 V)$





Absolute Maximum Ratings T _A =25℃ unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	20	V				
Gate-Source Voltage		V_{GS}	±12	V				
Continuous Drain	T _A =25℃		5					
Current ^A	T _A =70℃	I _D	4	А				
Pulsed Drain Current ^B		I _{DM}	25					
Power Dissipation ^A	T _A =25℃ T _A =70℃	Р	1.3	W				
	T _A =70℃	P_{D}	0.8	VV				
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s		76	95	€\M			
Maximum Junction-to-Ambient A	Steady State	eady State		150	€\M			
Maximum Junction-to-Lead ^C	Steady State	$R_{ hetaJL}$	54	68	℃/W			

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20V, V_{GS} = 0V$			1				
		T _J = 55℃			5	μΑ			
I_{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 10V$			±10	υΑ			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$	0.5	0.7	1	V			
$I_{D(ON)}$	On state drain current	$V_{GS} = 4.5V, V_{DS} = 5V$	25			Α			
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5V, I_D = 5.0A$	18	23	28	m O			
		T _J =125℃	26	33	40	mΩ			
		$V_{GS} = 4.0V, I_D = 4.5A$	19	24	30	mΩ			
		$V_{GS} = 3.1V, I_D = 4.5A$	20	27	34	mΩ			
		$V_{GS} = 2.5V, I_D = 4.0A$	21	30	39	mΩ			
g _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		18		S			
V_{SD}	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.65	1	V			
Is	Maximum Body-Diode Continuous Current				1.3	Α			
DYNAMIC	PARAMETERS								
C _{iss}	Input Capacitance			180	225	pF			
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		95		pF			
C _{rss}	Reverse Transfer Capacitance	1 1		18		pF			
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.7	4	kΩ			
SWITCHI	NG PARAMETERS								
Q_g	Total Gate Charge			5.6	7.5	nC			
Q_{gs}	Gate Source Charge	V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 5A		0.85		nC			
Q_{gd}	Gate Drain Charge	1 1		1.7		nC			
t _{D(on)}	Turn-On DelayTime			172		ns			
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =10V, R_{L} =2.0 Ω ,		368		ns			
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		2.94		บร			
t _f	Turn-Off Fall Time	1 1		2.5		บร			
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dl/dt=100A/μs		32	43	ns			
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs		3.2		nC			

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ = 25°C. in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

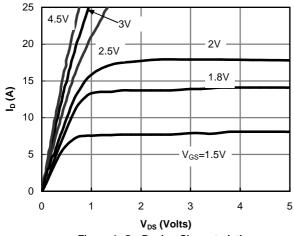


Figure 1: On-Region Characteristics

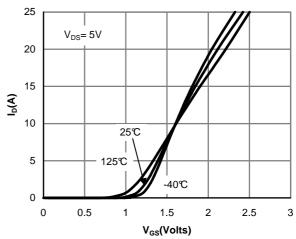


Figure 2: Transfer Characteristics

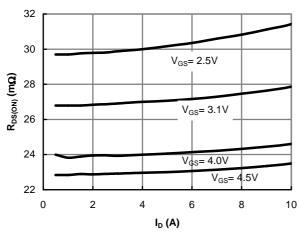


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

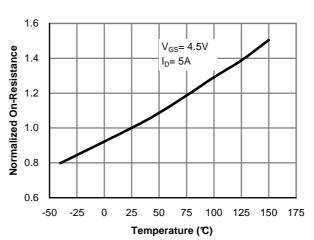


Figure 4: On-Resistance vs. Junction Temperature

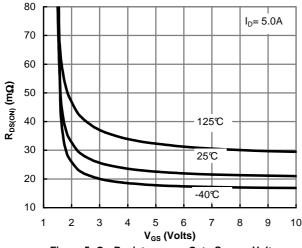


Figure 5: On-Resistance vs. Gate-Source Voltage

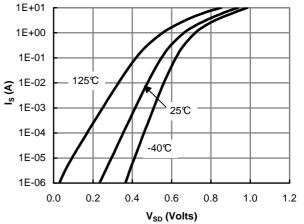


Figure 6: Body-Diode Characteristics

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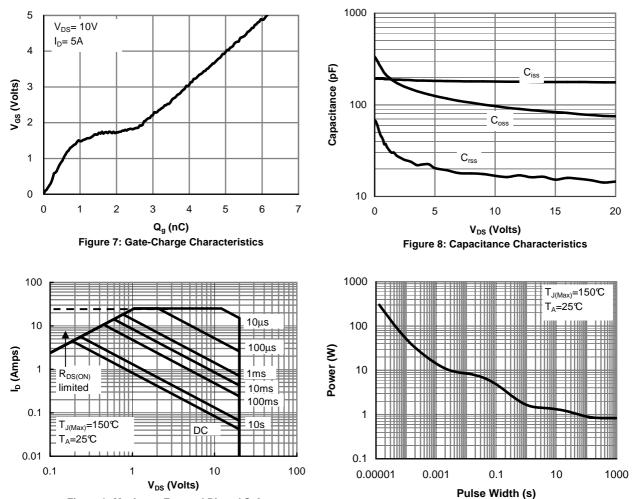


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junctionto-Ambient (Note E)

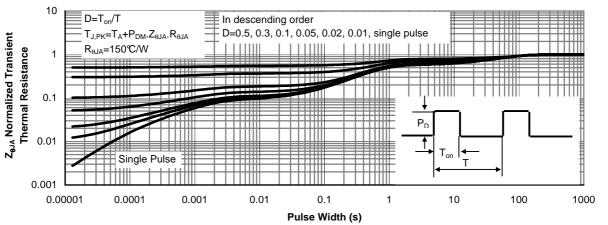
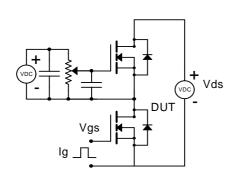
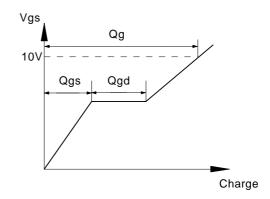


Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

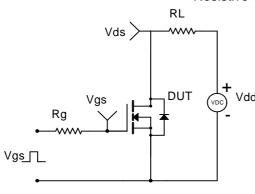
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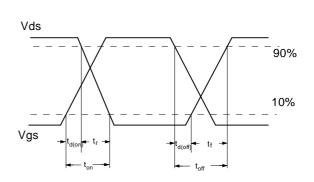
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

